

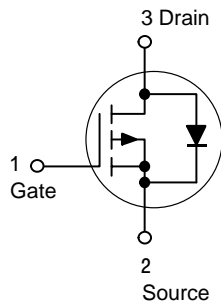
# Power MOSFET

## 130 mAmps, 50 Volts

### P-Channel SOT-23

These miniature surface mount MOSFETs reduce power loss conserve energy, making this device ideal for use in small power management circuitry. Typical applications are dc-dc converters, load switching, power management in portable and battery-powered products such as computers, printers, cellular and cordless telephones.

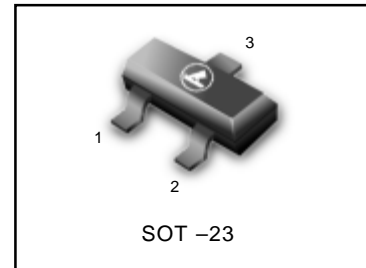
- Energy Efficient
- Miniature SOT-23 Surface Mount Package Saves Board Space
- Pb-Free Package is available.



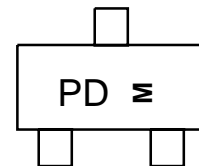
#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>	50	V <sub>dc</sub>
Gate-to-Source Voltage – Continuous	V <sub>GS</sub>	± 20	V <sub>dc</sub>
Drain Current	I <sub>D</sub>	130	mA
– Pulsed Drain Current (t <sub>p</sub> ≤ 10 μs)	I <sub>DM</sub>	520	
Total Power Dissipation @ T <sub>A</sub> = 25°C	P <sub>D</sub>	225	mW
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C
Thermal Resistance – Junction-to-Ambient	R <sub>θJA</sub>	556	°C/W
Maximum Lead Temperature for Soldering Purposes, for 10 seconds	T <sub>L</sub>	260	°C

## LBSS84LT1G



#### Marking Diagram



PD = Device Code  
M = Month Code

#### ORDERING INFORMATION

Device	Package	Shipping
LBSS84LT1G	SOT-23	3000/Tape&Reel
LBSS84LT3G	SOT-23	10000/Tape&Reel

**LBSS84LT1G**
**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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**OFF CHARACTERISTICS**

Drain-to-Source Breakdown Voltage ( $V_{GS} = 0\text{ Vdc}$ , $I_D = 250\ \mu\text{Adc}$ )	$V_{(BR)DSS}$	50	–	–	Vdc
Zero Gate Voltage Drain Current ( $V_{DS} = 25\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ ) ( $V_{DS} = 50\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ ) ( $V_{DS} = 50\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ , $T_J = 125^\circ\text{C}$ )	$I_{DSS}$	–	–	0.1 15 60	$\mu\text{Adc}$
Gate-Body Leakage Current ( $V_{GS} = \pm 20\text{ Vdc}$ , $V_{DS} = 0\text{ Vdc}$ )	$I_{GSS}$	–	–	$\pm 10$	nAdc

**ON CHARACTERISTICS** (Note 1.)

Gate-Source Threshold Voltage ( $V_{DS} = V_{GS}$ , $I_D = 1.0\text{ mAdc}$ )	$V_{GS(th)}$	0.8	–	2.0	Vdc
Static Drain-to-Source On-Resistance ( $V_{GS} = 5.0\text{ Vdc}$ , $I_D = 100\text{ mAdc}$ )	$r_{DS(on)}$	–	5.0	10	Ohms
Transfer Admittance ( $V_{DS} = 25\text{ Vdc}$ , $I_D = 100\text{ mAdc}$ , $f = 1.0\text{ kHz}$ )	$ y_{fs} $	50	–	–	mS

**DYNAMIC CHARACTERISTICS**

Input Capacitance	( $V_{DS} = 5.0\text{ Vdc}$ )	$C_{iss}$	–	30	–	pF
Output Capacitance	( $V_{DS} = 5.0\text{ Vdc}$ )	$C_{oss}$	–	10	–	
Transfer Capacitance	( $V_{DG} = 5.0\text{ Vdc}$ )	$C_{rss}$	–	5.0	–	

**SWITCHING CHARACTERISTICS** (Note 2.)

Turn-On Delay Time	$(V_{DD} = -15\text{ Vdc}$ , $I_D = -2.5\text{ Adc}$ , $R_L = 50\ \Omega$ )	$t_{d(on)}$	–	2.5	–	ns
Rise Time		$t_r$	–	1.0	–	
Turn-Off Delay Time		$t_{d(off)}$	–	16	–	
Fall Time		$t_f$	–	8.0	–	
Gate Charge		$Q_T$	–	6000	–	pC

**SOURCE-DRAIN DIODE CHARACTERISTICS**

Continuous Current	$I_S$	–	–	0.130	A
Pulsed Current	$I_{SM}$	–	–	0.520	
Forward Voltage (Note 2.)	$V_{SD}$	–	2.5	–	V

1. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
2. Switching characteristics are independent of operating junction temperature.

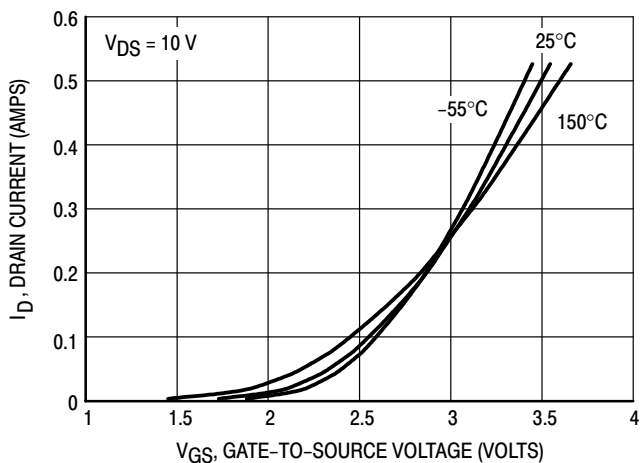
**TYPICAL ELECTRICAL CHARACTERISTICS**


Figure 1. Transfer Characteristics

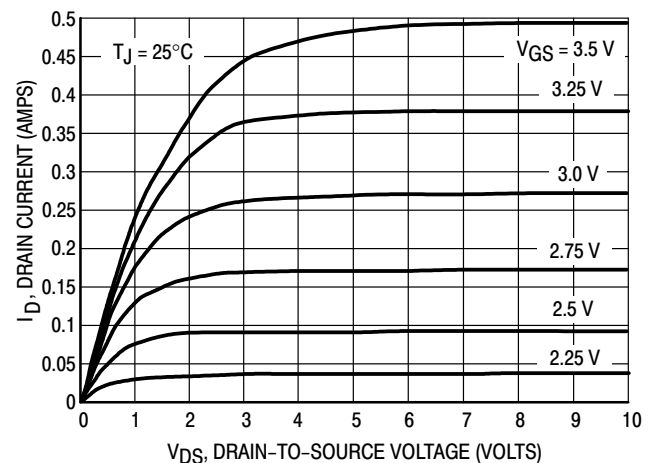


Figure 2. On-Region Characteristics

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TYPICAL ELECTRICAL CHARACTERISTICS

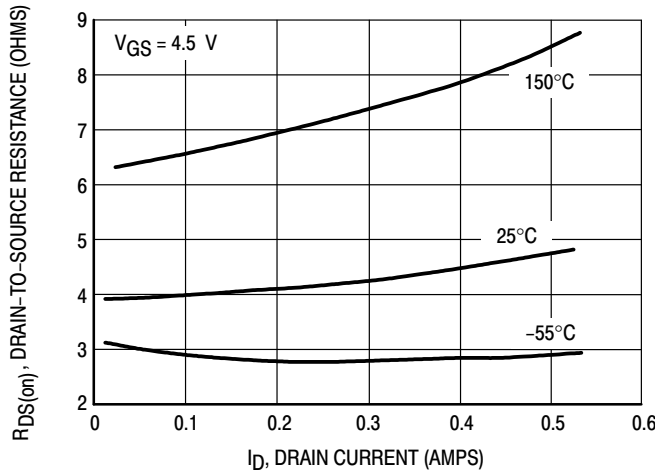


Figure 3. On-Resistance versus Drain Current

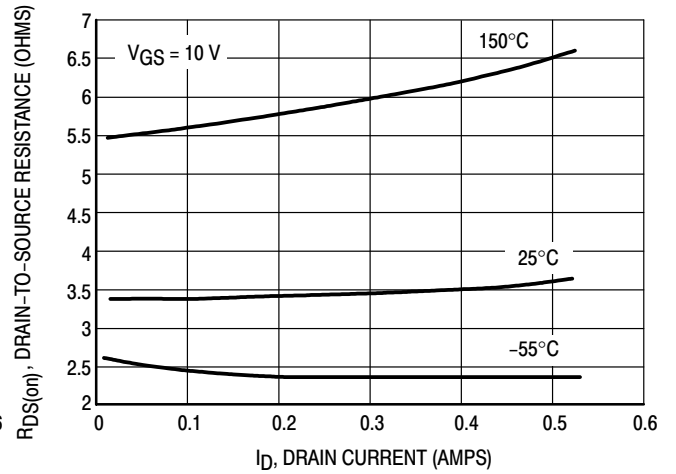


Figure 4. On-Resistance versus Drain Current

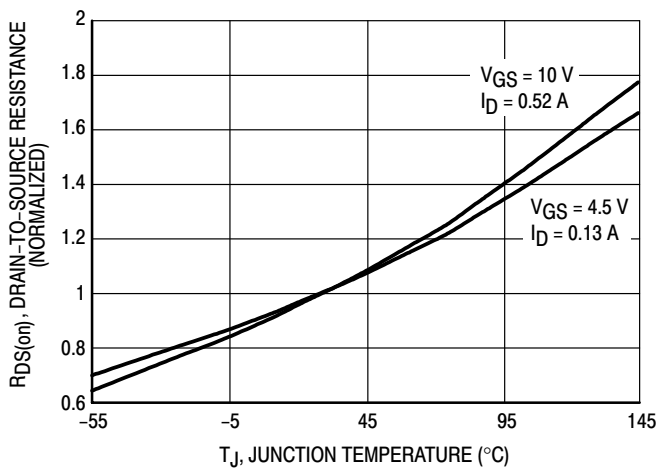


Figure 5. On-Resistance Variation with Temperature

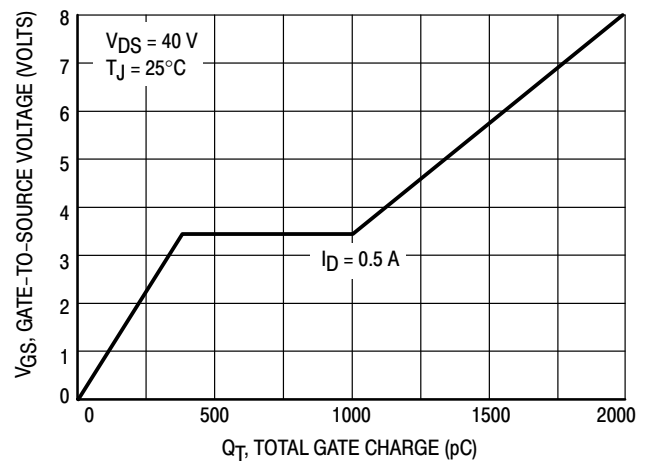


Figure 6. Gate Charge

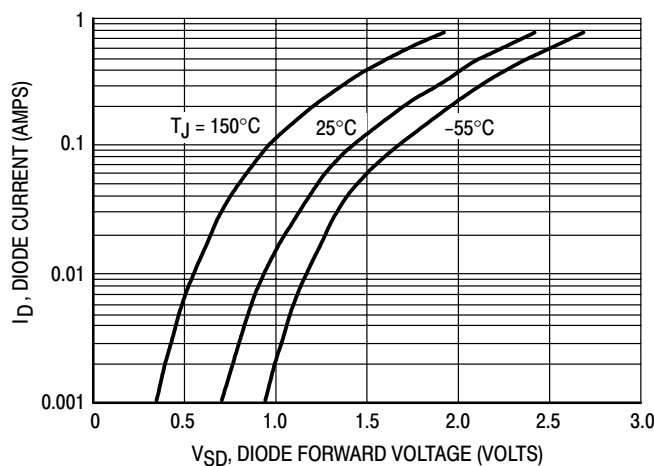
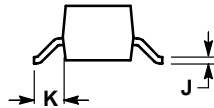
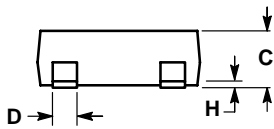
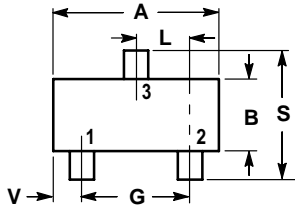


Figure 7. Body Diode Forward Voltage

**LBSS84LT1G**

**SOT-23**



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

- PIN 1. BASE  
 2. EMITTER  
 3. COLLECTOR

